Docket No.: 42P11468D

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In-Rollie Application of:

MADHAV DATTA

Application No.: 10/776,076

Filed: February 10, 2004

For: **COPPER-CONTAINING C4**

BALL-LIMITTING METALLURGE STACK FOR ENHANCED RELIABLITY OF PACKAGED STRUCTURES AND

METHOD OF MAKING SAME

Art Group: 2813

Examiner: Thanhha S. Pham

INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. §1.97

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

In accordance with the duty of disclosure, enclosed is a copy of IDS Citation Form PTO/SB/08 or PTO-1449, together with copies of the documents cited on that form, except for copies not required to be submitted (e.g., copies of U.S. patents and U.S. published patent applications need not be enclosed). This IDS and IDS Citation Form are being submitted before the mailing of a final Office Action. It is respectfully requested that the cited references be considered and that the enclosed copy of PTO/SB/08 be initialed by the Examiner to indicate such consideration and a copy thereof returned to applicant(s). Some or all of the references listed on the enclosed PTO/SB/08 were previously identified in the parent application (Application No. 09/961,034, filed September 21, 2001) and copies of the references were furnished at that time. Accordingly, per 37 CFR §1.98(d)(1) additional copies of those references are not submitted herewith.

The submission of this Information Disclosure Statement is not to be construed as a representation that a search has been made in the subject application and is not to be construed as an admission that the information cited in this statement is material to patentability.

Respectfully submitted,

BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN LLP

Date: 5/16/05

Michael A. Bernadicou, Reg. No. 35,934

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I hereby certify that this correspondence is being deposited with the United States Postal Service on the date shown below with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

Renee Coulman

Date

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Substitute for form 1449A/PTO

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(use as many sheets as necessary)

Sheet 1 of 3

| Complete if Known | | | | |
|------------------------|-------------------|--|--|--|
| Application Number | 10/776,076 | | | |
| Filing Date | February 10, 2004 | | | |
| First Named Inventor | Madhav Datta | | | |
| Art Unit | 2813 | | | |
| Examiner Name | Thanhha S. Pham | | | |
| Attorney Docket Number | 42P11468D | | | |

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Based on PTO/SB/08A (08-03) as modified by Blakely, Solokoff, Taylor & Zafman (wlr) 08/11/2003.

^{*}Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication.

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STATEMENT BY APPLICANT

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Sheet 2 **of** 3

| Complete if Known | | | | |
|------------------------|-------------------|--|--|--|
| Application Number | 10/776,076 | | | |
| Filing Date | February 10, 2004 | | | |
| First Named Inventor | Madhay Datta | | | |
| Art Unit | 2813 | | | |
| Examiner Name | Thanhha S. Pham | | | |
| Attorney Docket Number | 42P11468D | | | |

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|-----------------------------------------------------------------------------|---|-----------------------------------------------------|-------------------------------------------------|------------------------|------------------|
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| SIAI | | AFFLI | CAN | Art Unit | 2813 |
| | | | | Examiner Name | Thanhha S. Pham |
| Sheet | 3 | of | 3 | Attorney Docket Number | 42P11468D |

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